



DMN3009SFGQ

30V N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI3333-8

# **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(on)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C		
001/	5.5mΩ @ V <sub>GS</sub> = 10V	45A		
30V	9mΩ @ V <sub>GS</sub> = 4.5V	30A		

### **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Power Management Functions
- DC-DC Converters
- Batteries

#### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN3009SFGQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

## **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3009SFGQ-7	PowerDI3333-8	2,000/Tape & Reel
DMN3009SFGQ-13	PowerDI3333-8	3,000/Tape & Reel

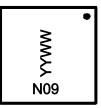
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



N09 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 21 = 2021) WW = Week Code (01 to 53)

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## Maximum Ratings (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	30	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
	T <sub>A</sub> = +25°C	l <sub>D</sub>	16	А
Continuous Durin Current $M_{\rm eff} = 40M/(Mate C)$	T <sub>A</sub> = +70°C		13	
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	T <sub>C</sub> = +25°C		45	А
	T <sub>C</sub> = +70°C		35	
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	80	А
Maximum Continuous Body Diode Forward Current (Note 6)		Is	20	А
Avalanche Current, L = 0.1mH	I <sub>AS</sub>	33	А	
Avalanche Energy, L = 0.1mH		Eas	55	mJ

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.9	W	
	T <sub>A</sub> = +70°C	FD	0.6		
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	137	°C/W		
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	D	2.1	W	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +70°C	PD	1.4	vv	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	59	°C/W	
Thermal Resistance, Junction to Case (Note 6)	R <sub>θJC</sub>	7.8	°C/W		
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

### Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS		_	1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	1	1.4	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance			4.0	5.5	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	
Static Dialit-Source Off-Resistance	R <sub>DS(on)</sub>	_	4.9	9	11122	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 16A	
Diode Forward Voltage	V <sub>SD</sub>	_	0.68	1	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2,000	—	pF		
Output Capacitance	Coss	_	315	_	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, - f = 1MHz	
Reverse Transfer Capacitance	Crss	_	248	—	pF		
Gate Resistance	Rg	_	2.2	—	Ω	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f = 1MHz	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	20	—	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	42	—	nC		
Gate-Source Charge	Q <sub>gs</sub>		4.7	_	nC	V <sub>DS</sub> = 15V, I <sub>D</sub> = 15A	
Gate-Drain Charge	Q <sub>gd</sub>	_	7.4	—	nC		
Turn-On Delay Time	t <sub>D(on)</sub>	_	3.9	—	ns		
Turn-On Rise Time	t <sub>R</sub>	_	4.1	_	ns	V <sub>DD</sub> = 15V, V <sub>GS</sub> = 10V, R <sub>G</sub> = 3.3Ω, I <sub>D</sub> = 15A	
Turn-Off Delay Time	t <sub>D(off)</sub>	—	31	—	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	14.6	—	ns		
Reverse Recovery Time	t <sub>RR</sub>	—	15	—	ns	1 - 150 di/dt - 1000/us	
Reverse Recovery Charge	Q <sub>RR</sub>		6	—	nC	I <sub>F</sub> = 15A, di/dt = 100A/µs	

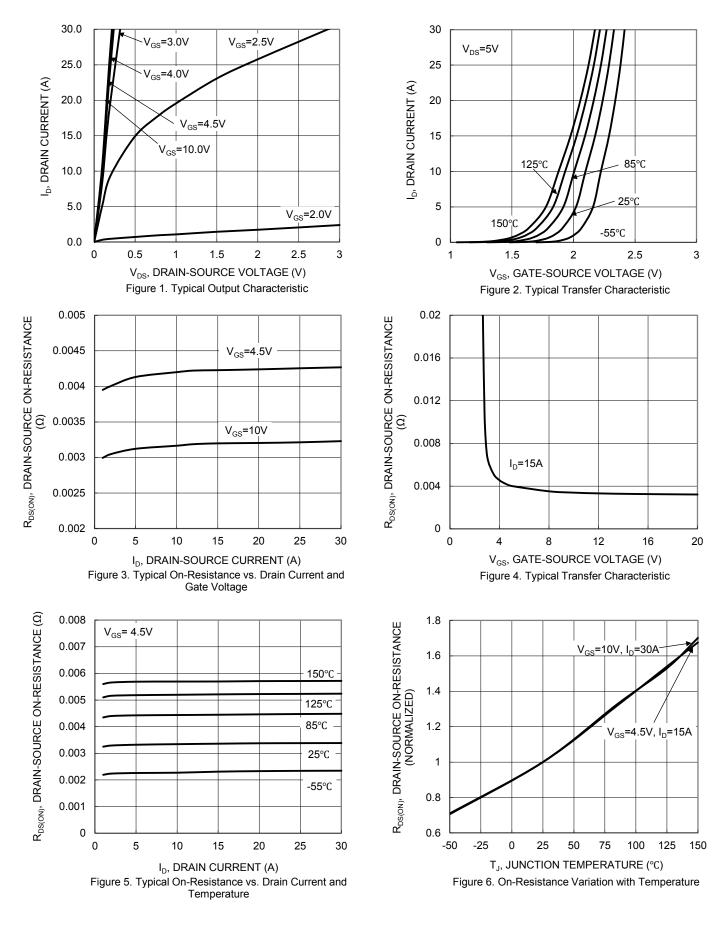
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to production testing.



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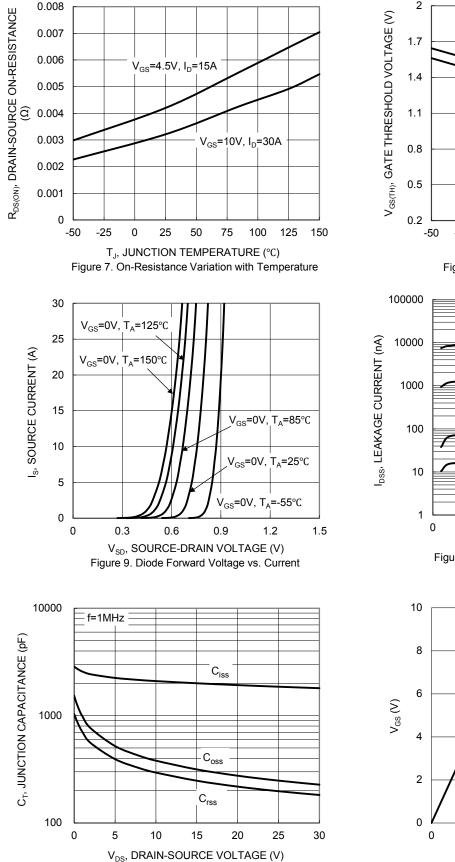
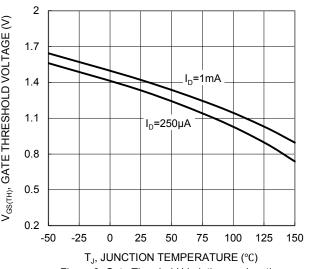
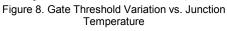
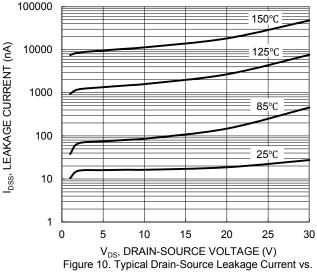


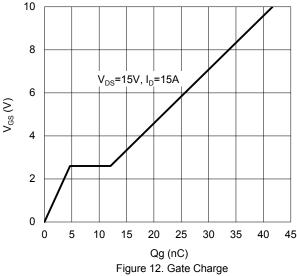
Figure 11. Typical Junction Capacitance





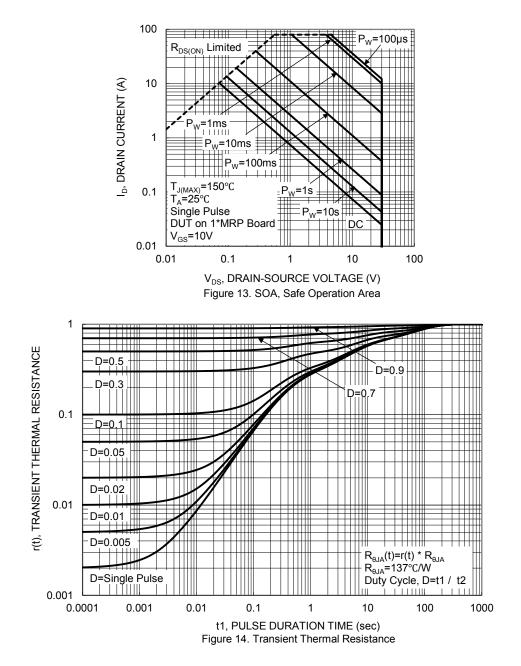


Voltage



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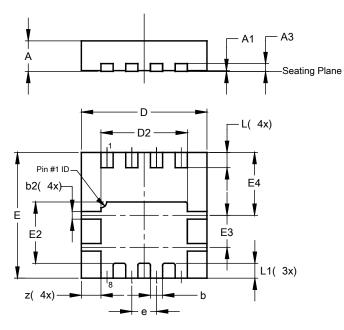






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

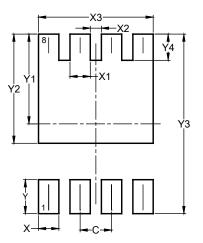


	PowerDI3333-8					
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3	-	-	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
Е	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е	-	-	0.65			
L	0.35	0.45	0.40			
L1	_	-	0.39			
z	_	_	0.515			
All I	All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
X3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540

#### PowerDI3333-8



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